# 1:5 Differential (LV)PECL/(LV)ECL/ HSTL Clock and Data Driver

## ABSOLUTE MAXIMUM RATINGS

$V_{CC}$ - $V_{EE}$.....................................................................6.0V
Single-Ended Inputs (SCLK, SEL, $\overline{EN}$, CLK, $\overline{CLK}$)
   For $V_{CC}$ - $V_{EE}$ ≤ 4.2V.........................$V_{EE}$ - 0.3V to $V_{CC}$ + 0.3V
   For $V_{CC}$ - $V_{EE}$ > 4.2V .......................$V_{EE}$ - 4.2V to $V_{CC}$ + 0.3V
CLK to $\overline{CLK}$ .................................................................±3.0V
Continuous Output Current.................................................50mA
Surge Output Current........................................................100mA
$V_{BB}$ Sink/Source Current ...............................................±0.65mA
Continuous Power Dissipation ($T_A$ = +70°C)
  Single-Layer PC Board
   20-Pin Wide SO (derate 10mW/°C above +70°C) ......800mW
Junction-to-Ambient Thermal Resistance in Still Air
  Single-Layer PC Board
   20-Pin Wide SO…...................................................+100°C/W

Junction-to-Ambient Thermal Resistance with
  500LFPM Airflow
  Single-Layer PC Board
   20-Pin Wide SO…....................................................+58°C/W
Junction-to-Case Thermal Resistance
  20-Pin Wide SO…....................................................+20°C/W
Operating Temperature Range ..........................-40°C to +85°C
Junction Temperature ....................................................+150°C
Storage Temperature Range ............................-65°C to +150°C
ESD Protection
  Human Body Model (Inputs and Outputs) .........................2kV
Lead Temperature (soldering, 10s) ................................+300°C

*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

## DC ELECTRICAL CHARACTERISTICS

($V_{CC}$ - $V_{EE}$ = 3.0V to 5.5V, outputs loaded with 50Ω ±1% to $V_{CC}$ - 2V, SEL = high or low, $\overline{EN}$ = low, unless otherwise noted. Typical values are at $V_{CC}$ - $V_{EE}$ = 5.0V, $V_{IHD}$ = $V_{CC}$ - 1V, $V_{ILD}$ = $V_{CC}$ - 1.5V.) (Notes 1, 2, 3)

| PARAMETER | SYMBOL | CONDITIONS | -40°C MIN | -40°C TYP | -40°C MAX | +25°C MIN | +25°C TYP | +25°C MAX | +85°C MIN | +85°C TYP | +85°C MAX | UNITS |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| **SINGLE-ENDED INPUTS (SCLK, SEL, $\overline{EN}$)** | | | | | | | | | | | | |
| Input High Voltage | $V_{IH}$ | | $V_{CC}$ - 1.095 | | $V_{CC}$ | $V_{CC}$ - 1.125 | | $V_{CC}$ | $V_{CC}$ - 1.125 | | $V_{CC}$ | V |
| Input Low Voltage | $V_{IL}$ | ($V_{CC}$ - $V_{EE}$) ≤ 4.2 | $V_{EE}$ | | $V_{CC}$ - 1.495 | $V_{EE}$ | | $V_{CC}$ - 1.495 | $V_{EE}$ | | $V_{CC}$ - 1.575 | V |
| | | ($V_{CC}$ - $V_{EE}$) > 4.2V | $V_{CC}$ - 4.2 | | $V_{CC}$ - 1.495 | $V_{CC}$ - 4.2 | | $V_{CC}$ - 1.495 | $V_{CC}$ - 4.2 | | $V_{CC}$ - 1.575 | |
| Input Current | $I_{IN}$ | $V_{IL(MIN)}$, $V_{IH(MAX)}$ | -300 | | +300 | -300 | | +300 | -300 | | +300 | μA |
| **DIFFERENTIAL INPUTS (CLK, $\overline{CLK}$)** | | | | | | | | | | | | |
| Single-Ended Input High Voltage | $V_{IH}$ | $\overline{CLK}$ connected to $V_{BB}$, Figure 1 | $V_{CC}$ - 1.095 | | $V_{CC}$ | $V_{CC}$ - 1.125 | | $V_{CC}$ | $V_{CC}$ - 1.125 | | $V_{CC}$ | V |
| Single-Ended Input Low Voltage | $V_{IL}$ | $\overline{CLK}$ connected to $V_{BB}$, Figure 1 ($V_{CC}$ - $V_{EE}$) ≤ 4.2V | $V_{EE}$ | | $V_{CC}$ - 1.495 | $V_{EE}$ | | $V_{CC}$ - 1.495 | $V_{EE}$ | | $V_{CC}$ - 1.575 | V |
| | | $\overline{CLK}$ connected to $V_{BB}$, Figure 1 ($V_{CC}$ - $V_{EE}$) > 4.2V | $V_{CC}$ - 4.2 | | $V_{CC}$ - 1.495 | $V_{CC}$ - 4.2 | | $V_{CC}$ - 1.495 | $V_{CC}$ - 4.2 | | $V_{CC}$ - 1.575 | |
| High Voltage of Differential Input | $V_{IHD}$ | | $V_{EE}$ + 1.2 | | $V_{CC}$ | $V_{EE}$ + 1.2 | | $V_{CC}$ | $V_{EE}$ + 1.2 | | $V_{CC}$ | V |
| Low Voltage of Differential Input | $V_{ILD}$ | | $V_{EE}$ | | $V_{CC}$ - 0.095 | $V_{EE}$ | | $V_{CC}$ - 0.095 | $V_{EE}$ | | $V_{CC}$ - 0.095 | V |

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## DC ELECTRICAL CHARACTERISTICS (continued)

($V_{CC}$ - $V_{EE}$ = 3.0V to 5.5V, outputs loaded with 50Ω ±1% to $V_{CC}$ - 2V, SEL = high or low, $\overline{EN}$ = low, unless otherwise noted. Typical values are at $V_{CC}$ - $V_{EE}$ = 5.0V, $V_{IHD}$ = $V_{CC}$ - 1V, $V_{ILD}$ = $V_{CC}$ - 1.5V.) (Notes 1, 2, 3)

| PARAMETER | SYMBOL | CONDITIONS | -40°C | | | +25°C | | | +85°C | | | UNITS |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| Differential Input Voltage | $V_{IHD}$ - $V_{ILD}$ | | 0.095 | | 3.0 | 0.095 | | 3.0 | 0.095 | | 3.0 | V |
| Input Current | $I_{IN}$ | $V_{IH}$, $V_{IL}$, $V_{IHD}$, $V_{ILD}$ | -300 | | +300 | -300 | | +300 | -300 | | +300 | µA |
| **OUTPUTS (Q_, $\overline{\text{Q}}$_)** | | | | | | | | | | | | |
| Single-Ended Output High Voltage | $V_{OH}$ | Figure 1 | $V_{CC}$ - 1.085 | | $V_{CC}$ - 0.865 | $V_{CC}$ - 1.025 | | $V_{CC}$ - 0.865 | $V_{CC}$ - 1.025 | | $V_{CC}$ - 0.865 | V |
| Single-Ended Output Low Voltage | $V_{OL}$ | Figure 1 | $V_{CC}$ - 1.910 | | $V_{CC}$ - 1.555 | $V_{CC}$ - 1.840 | | $V_{CC}$ - 1.620 | $V_{CC}$ - 1.810 | | $V_{CC}$ - 1.620 | V |
| Differential Output Voltage | $V_{OH}$ - $V_{OL}$ | Figure 1 | 550 | | 910 | 550 | | 910 | 550 | | 910 | mV |
| **REFERENCE ($V_{BB}$)** | | | | | | | | | | | | |
| Reference Voltage Output (Note 4) | $V_{BB}$ | $I_{BB}$ = ±0.5mA | $V_{CC}$ - 1.40 | | $V_{CC}$ - 1.19 | $V_{CC}$ - 1.40 | | $V_{CC}$ - 1.22 | $V_{CC}$ - 1.48 | | $V_{CC}$ - 1.22 | V |
| **POWER SUPPLY** | | | | | | | | | | | | |
| Supply Current (Note 5) | $I_{EE}$ | | | 30 | 40 | | 32 | 40 | | 34 | 43 | mA |

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## AC ELECTRICAL CHARACTERISTICS

($V_{CC}$ - $V_{EE}$ = 3.0V to 5.5V, outputs are loaded with 50Ω ±1% to $V_{CC}$ - 2V, input frequency ≤ 1.5GHz, input transition time = 125ps (20% to 80%), SEL = high or low, $\overline{EN}$ = low, $V_{IHD}$ = $V_{EE}$ + 1.2V to $V_{CC}$, $V_{ILD}$ = $V_{EE}$ to $V_{CC}$ - 0.15V, $V_{IHD}$ - $V_{ILD}$ = 0.15V to 3V, unless otherwise noted. Typical values are at $V_{CC}$ - $V_{EE}$ = 5.0V.) (Notes 1, 6)

| PARAMETER | SYMBOL | CONDITIONS | -40°C | | | +25°C | | | +85°C | | | UNITS |
|---|---|---|---|---|---|---|---|---|---|---|---|---|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| CLK to Q_ Delay (Differential) | $t_{PLHD1}$, $t_{PHLD1}$ | Figure 2 | 290 | | 400 | 310 | | 440 | 300 | | 520 | ps |
| SCLK to Q_ Delay | $t_{PLHD3}$, $t_{PHLD3}$ | $V_{IL}$ = $V_{CC}$ - 1.55V, $V_{IH}$ = $V_{CC}$ - 1.09V, Figure 3 | 290 | | 400 | 310 | | 440 | 300 | | 520 | ps |
| Output-to-Output Skew (Note 7) | $t_{SKOO}$ | | | 5 | 30 | | 20 | 40 | | 20 | 50 | ps |
| Part-to-Part Skew (Note 8) | $t_{SKPP}$ | | | | 110 | | | 130 | | | 220 | ps |
| Added Random Jitter (Note 9) | $t_{RJ}$ | $f_{IN}$ = 1.5GHz clock | | 0.8 | 1.2 | | 0.8 | 1.2 | | 0.8 | 1.2 | ps (RMS) |
| Added Deterministic Jitter (Note 9) | $t_{DJ}$ | 1.5Gbps $2E^{23}$ - 1 PRBS pattern | | 50 | 70 | | 50 | 70 | | 50 | 70 | $Ps_{P-P}$ |
| Switching Frequency | $f_{MAX}$ | ($V_{OH}$ - $V_{OL}$) ≥ 400mV, Figure 2 | 1.5 | | | 1.5 | | | 1.5 | | | GHz |
| Output Rise/Fall Time (20% to 80%) | $t_R$, $t_F$ | Figure 2 | 80 | | 120 | 90 | | 130 | 90 | | 145 | ps |

**Note 1:** Measurements are made with the device in thermal equilibrium.
**Note 2:** Current into a pin is defined as positive. Current out of a pin is defined as negative.
**Note 3:** DC parameters are production tested at $T_A$ = +25°C and guaranteed by design over the full operating temperature range.
**Note 4:** Use $V_{BB}$ only for inputs that are on the same device as the $V_{BB}$ reference.
**Note 5:** All pins are open except $V_{CC}$ and $V_{EE}$.
**Note 6:** Guaranteed by design and characterization. Limits are set at ±6 sigma.
**Note 7:** Measured between outputs of the same part at the signal crossing points for a same-edge transition.
**Note 8:** Measured between outputs of different parts at the signal crossing points under identical conditions for a same-edge transition.
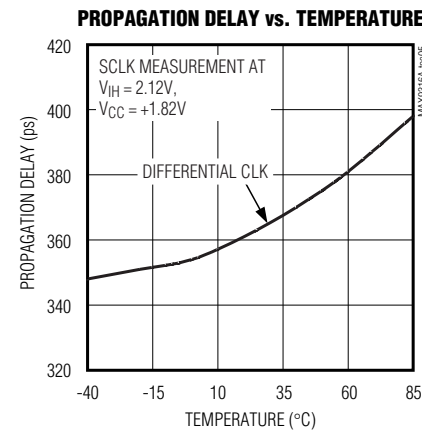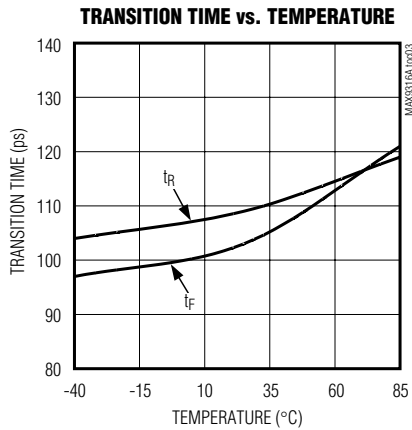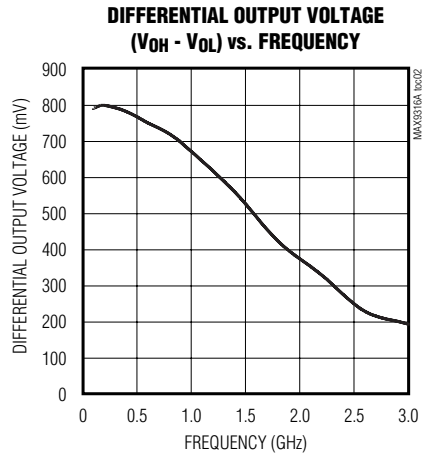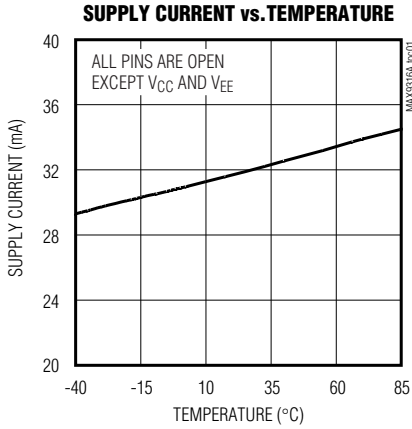**Note 9:** Device jitter added to a jitter-free input signal.

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## _Typical Operating Characteristics_

($V_{CC}$ = 5.0V, $V_{IHD}$ = $V_{CC}$ - 1V, $V_{ILD}$ = $V_{CC}$ - 1.15V, input transition time = 125ps (20% to 80%), $f_{IN}$ = 1.5GHz, outputs loaded with 50Ω to ($V_{CC}$ - 2V), $T_A$ = +25°C, unless otherwise noted.)

**SUPPLY CURRENT vs.TEMPERATURE**

ALL PINS ARE OPEN
EXCEPT $V_{CC}$ AND $V_{EE}$

**DIFFERENTIAL OUTPUT VOLTAGE ($V_{OH}$ - $V_{OL}$) vs. FREQUENCY**

**TRANSITION TIME vs. TEMPERATURE**

$t_R$

$t_F$

**PROPAGATION DELAY vs. TEMPERATURE**

SCLK MEASUREMENT AT
$V_{IH}$ = 2.12V,
$V_{CC}$ = +1.82V

DIFFERENTIAL CLK



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| PIN | NAME | FUNCTION |
|---|---|---|
| 1 | Q0 | Noninverting Q0 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 2 | $\overline{Q0}$ | Inverting Q0 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 3 | Q1 | Noninverting Q1 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 4 | $\overline{Q1}$ | Inverting Q1 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 5 | Q2 | Noninverting Q2 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 6 | $\overline{Q2}$ | Inverting Q2 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 7 | Q3 | Noninverting Q3 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 8 | $\overline{Q3}$ | Inverting Q3 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 9 | Q4 | Noninverting Q4 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 10 | $\overline{Q4}$ | Inverting Q4 Output. Typically terminate with 50Ω resistor to ($V_{CC}$ - 2V). |
| 11 | $V_{EE}$ | Negative Supply Voltage |
| 12 | SEL | Clock Select Input (Single Ended). Drive low to select the CLK, $\overline{CLK}$ input. Drive high to select the SCLK input. The SEL threshold is equal to $V_{BB}$. Internal 30kΩ pulldown to $V_{EE}$ and 30kΩ pullup to $V_{CC}$. |
| 13 | $V_{BB}$ | Reference Output Voltage. Connect to the inverting or noninverting clock input to provide a reference for single-ended operation. When used, bypass with a 0.01µF ceramic capacitor to $V_{CC}$; otherwise, leave it unconnected. |
| 14 | $\overline{CLK}$ | Inverting Differential Clock Input. Internal 45kΩ pullup to $V_{CC}$ and 45kΩ pulldown to $V_{EE}$. |
| 15 | CLK | Noninverting Differential Clock Input. Internal 30kΩ pulldown to $V_{EE}$ and 45kΩ pullup to $V_{CC}$. |
| 16 | SCLK | Single-Ended Clock Input. Internal 30kΩ pulldown to $V_{EE}$ and 45kΩ pullup to $V_{CC}$. |
| 17 | N.C. | Not Internally Connected. Solder to PC board for package thermal dissipation. |
| 18, 20 | $V_{CC}$ | Positive Supply Voltage. Bypass $V_{CC}$ to $V_{EE}$ with 0.1µF and 0.01µF ceramic capacitors. Place the capacitors as close to the device as possible with the smaller value capacitor closest to the device. |
| 19 | $\overline{EN}$ | Output Enable Input. Outputs are synchronously enabled on the falling edge of the clock input when $\overline{EN}$ is low. Outputs are synchronously set to low on the falling edge of the clock input when $\overline{EN}$ is high. Internal 30kΩ pulldown to $V_{EE}$ and 30kΩ pullup to $V_{CC}$. |

## _____**Detailed Description**

The MAX9316A is a low-skew, 1-to-5 differential driver designed for clock or data distribution. A 2-to-1 MUX selects one of the two clock inputs, CLK, $\overline{CLK}$ and SCLK. The CLK and $\overline{CLK}$ inputs are differential while the SCLK is single ended. The MUX is switched by the single-ended SEL input. A logic low selects the CLK input and a logic high selects the SCLK input. The SEL logic threshold is set by the internal voltage reference $V_{BB}$. SEL input can be driven by $V_{CC}$ and $V_{EE}$ or by a single-ended (LV)PECL/(LV)ECL signal. The selected input is reproduced at five differential outputs, Q0 to Q4.

### Synchronous Enable

The MAX9316A is synchronously enabled and disabled with outputs in the low state to eliminate shortened clock pulses. $\overline{EN}$ is connected to the input of an edge-triggered D flip-flop. After power-up, drive $\overline{EN}$ low and toggle the selected clock input to enable the outputs. The outputs are enabled on the falling edge of the selected clock input after $\overline{EN}$ goes low. The outputs are disabled to a low state on the falling edge of the selected clock input after $\overline{EN}$ goes high. The threshold for $\overline{EN}$ is equal to $V_{BB}$.

### Power Supply

For interfacing to differential HSTL and (LV)PECL signals, the $V_{CC}$ range is from 3.0 to 5.5V (with $V_{EE}$

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grounded), allowing high-performance clock or data distribution in systems with a nominal 5.0V supply. For interfacing to differential (LV)ECL, the $V_{EE}$ range is -3.0V to -5.5V (with $V_{CC}$ grounded). Output levels are referenced to $V_{CC}$ and are considered (LV)PECL or (LV)ECL, depending on the level of the $V_{CC}$ supply. With $V_{CC}$ connected to a positive supply and $V_{EE}$ connected to ground, the outputs are (LV)PECL. The outputs are (LV)ECL when $V_{CC}$ is connected to ground and $V_{EE}$ is connected to a negative supply.

### Input Bias Resistors
When the CLK and $\overline{CLK}$ inputs are open, the internal bias resistors set the inputs to differential low state. The inverting input ($\overline{CLK}$) is biased with a 45kΩ pullup to $V_{CC}$ and a 45kΩ pulldown to $V_{EE}$. The noninverting input (CLK) and SCLK are biased with a 45kΩ pullup to $V_{CC}$ and a 30kΩ pulldown to $V_{EE}$. The single-ended inputs (SEL, $\overline{EN}$) are each biased with a 30kΩ pulldown to $V_{EE}$ and a 30kΩ pullup to $V_{CC}$.

### Differential Clock Input Limits
The maximum magnitude of the differential signal applied to the differential clock input is 3.0V. This limit also applies to the difference between any reference voltage input and a single-ended input. Specifications for the high and low voltages of a differential input ($V_{IHD}$ and $V_{ILD}$) and the differential input voltage ($V_{IHD}$ - $V_{ILD}$) apply simultaneously.

### Single-Ended Clock Input and $V_{BB}$
The differential clock input can be configured to accept a single-ended input. This is accomplished by connecting the on-chip reference voltage, $V_{BB}$, to the inverting or noninverting input of the differential input as a reference. For example, the differential CLK, $\overline{CLK}$ input is converted to a noninverting, single-ended input by connecting $V_{BB}$ to $\overline{CLK}$ and connecting the single-ended input signal to CLK. Similarly, an inverting configuration is obtained by connecting $V_{BB}$ to CLK and connecting the single-ended input to $\overline{CLK}$. With a differential input configured as single ended (using $V_{BB}$), the single-ended input can be driven to $V_{CC}$ and $V_{EE}$ or with a single-ended (LV)PECL/(LV)ECL signal. Note that the single-ended input must be least $V_{BB}$ ±95mV or a differential input of at least 95mV to switch the outputs to the $V_{OH}$ and $V_{OL}$ levels specified in the *DC Electrical Characteristics* table.

When using the $V_{BB}$ reference output, bypass it with a 0.01μF ceramic capacitor to $V_{CC}$. If the $V_{BB}$ reference is not used, leave it open. The $V_{BB}$ reference can source or sink 0.5mA. Use $V_{BB}$ only for an input that is on the same device as the $V_{BB}$ reference.

### Supply Bypassing
Bypass $V_{CC}$ to $V_{EE}$ with high-frequency, surface-mount, ceramic, 0.1μF and 0.01μF capacitors in parallel as close to the device as possible, with the 0.01μF capacitor closest to the device. Use multiple parallel vias to minimize parasitic inductance. When using the $V_{BB}$ reference output, bypass it with a 0.01μF ceramic capacitor to $V_{CC}$ (if the $V_{BB}$ reference is not used, it can be left open).

### Controlled-Impedance Traces
Input and output trace characteristics affect the performance of the MAX9316A. Connect input and output signals with 50Ω characteristic impedance traces. Minimize the number of vias to prevent impedance discontinuities. Reduce reflections by maintaining the 50Ω characteristic impedance through cables and connectors. Reduce skew within a differential pair by matching the electrical length of the traces.

### Output Termination
Terminate outputs with 50Ω to $V_{CC}$ - 2V or use an equivalent Thevenin termination. When a single-ended signal is taken from a differential output, terminate both outputs. For example, if Q0 is used as a single-ended output, terminate both Q0 and $\overline{Q0}$.

# _____Chip Information
TRANSISTOR COUNT: 616
PROCESS: Bipolar
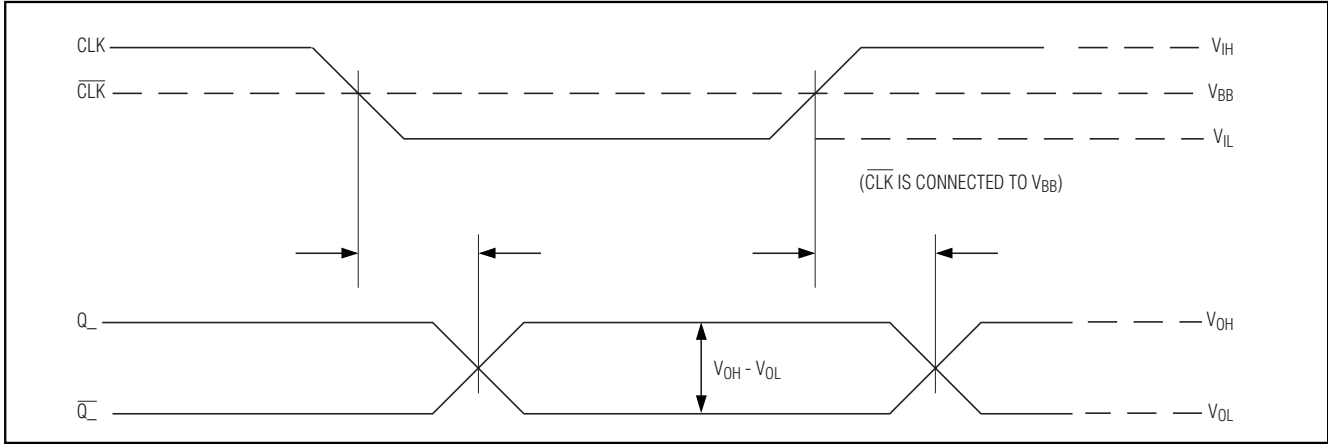
MAX9316A



Figure 1. MAX9316A Switching Characteristics with Single-Ended Input

In Figure 1 the following labels appear: CLK, $\overline{CLK}$, $V_{IH}$, $V_{BB}$, $V_{IL}$, ($\overline{CLK}$ IS CONNECTED TO $V_{BB}$), Q_, $\overline{Q}$_, $V_{OH}$, $V_{OH} - V_{OL}$, $V_{OL}$
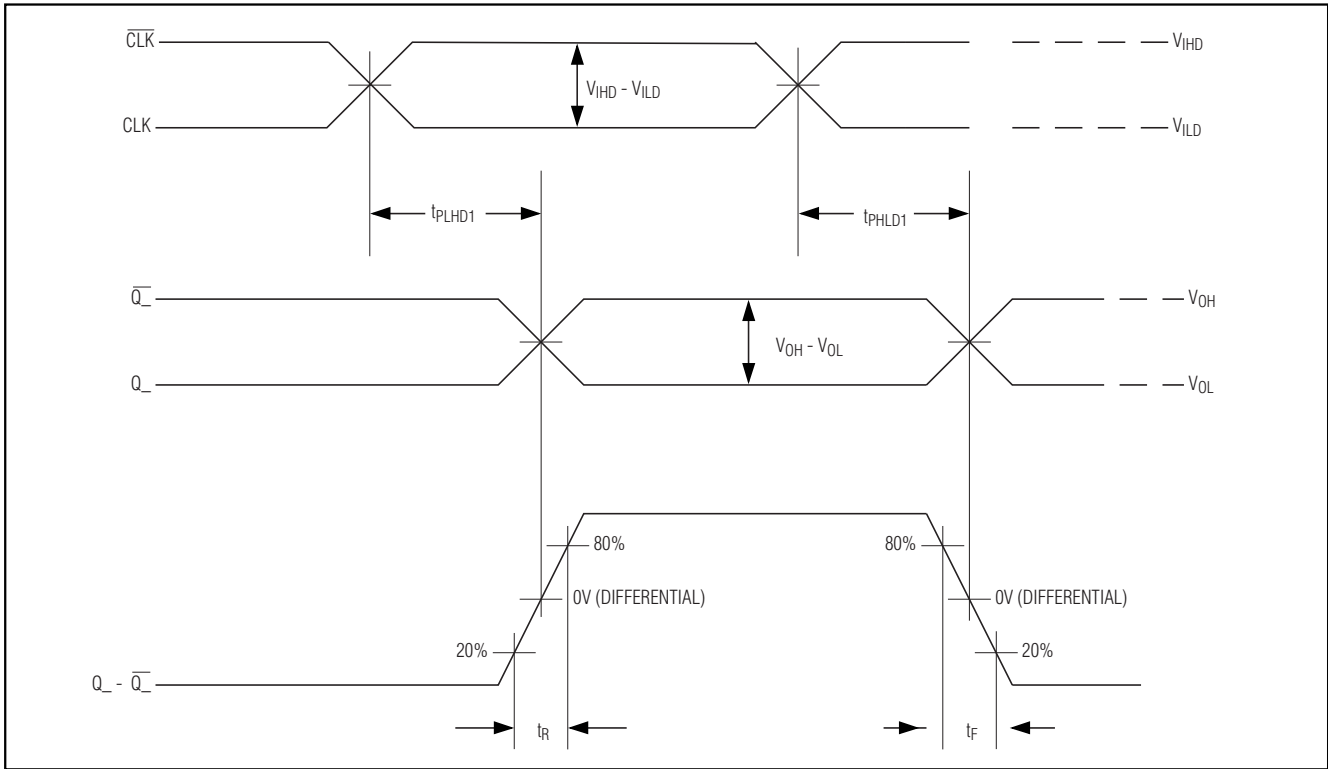


Figure 2. MAX9316A Timing Diagram

In Figure 2 the following labels appear: $\overline{CLK}$, CLK, $V_{IHD}$, $V_{IHD} - V_{ILD}$, $V_{ILD}$, $t_{PLHD1}$, $t_{PHLD1}$, $\overline{Q}$_, Q_, $V_{OH}$, $V_{OH} - V_{OL}$, $V_{OL}$, 80%, 0V (DIFFERENTIAL), 20%, Q_ - $\overline{Q}$_, $t_R$, $t_F$

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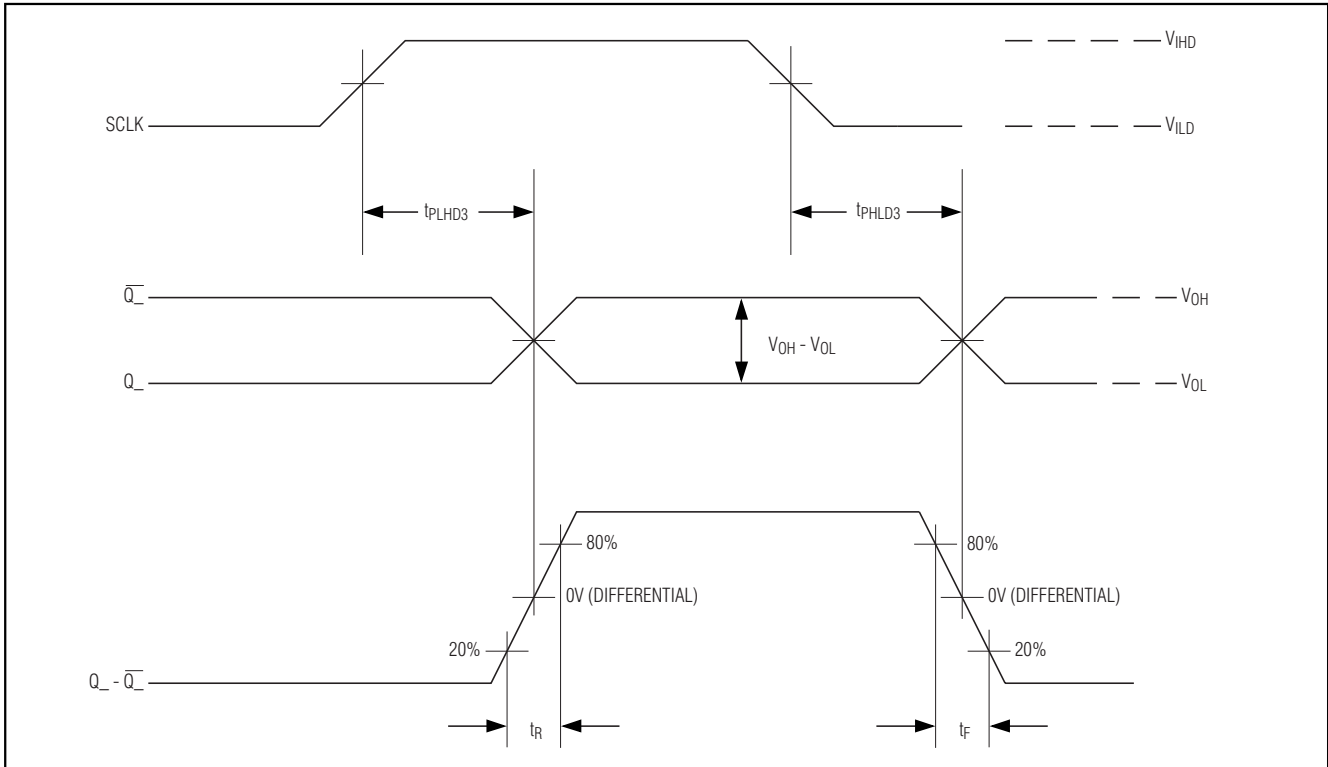
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Figure 3. MAX9316A Timing Diagram for SCLK
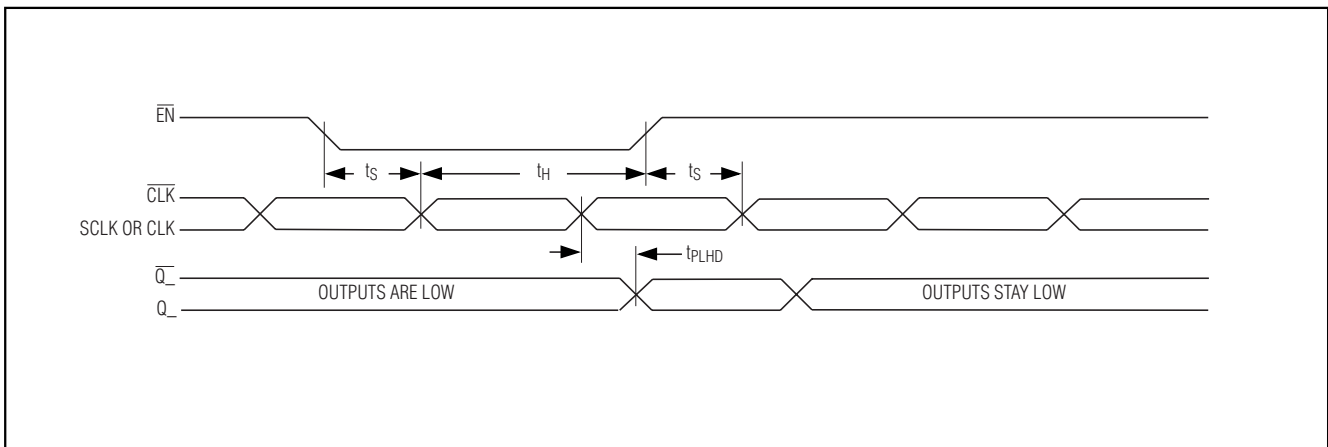


Figure 4. MAX9316A $\overline{EN}$ Timing Diagram

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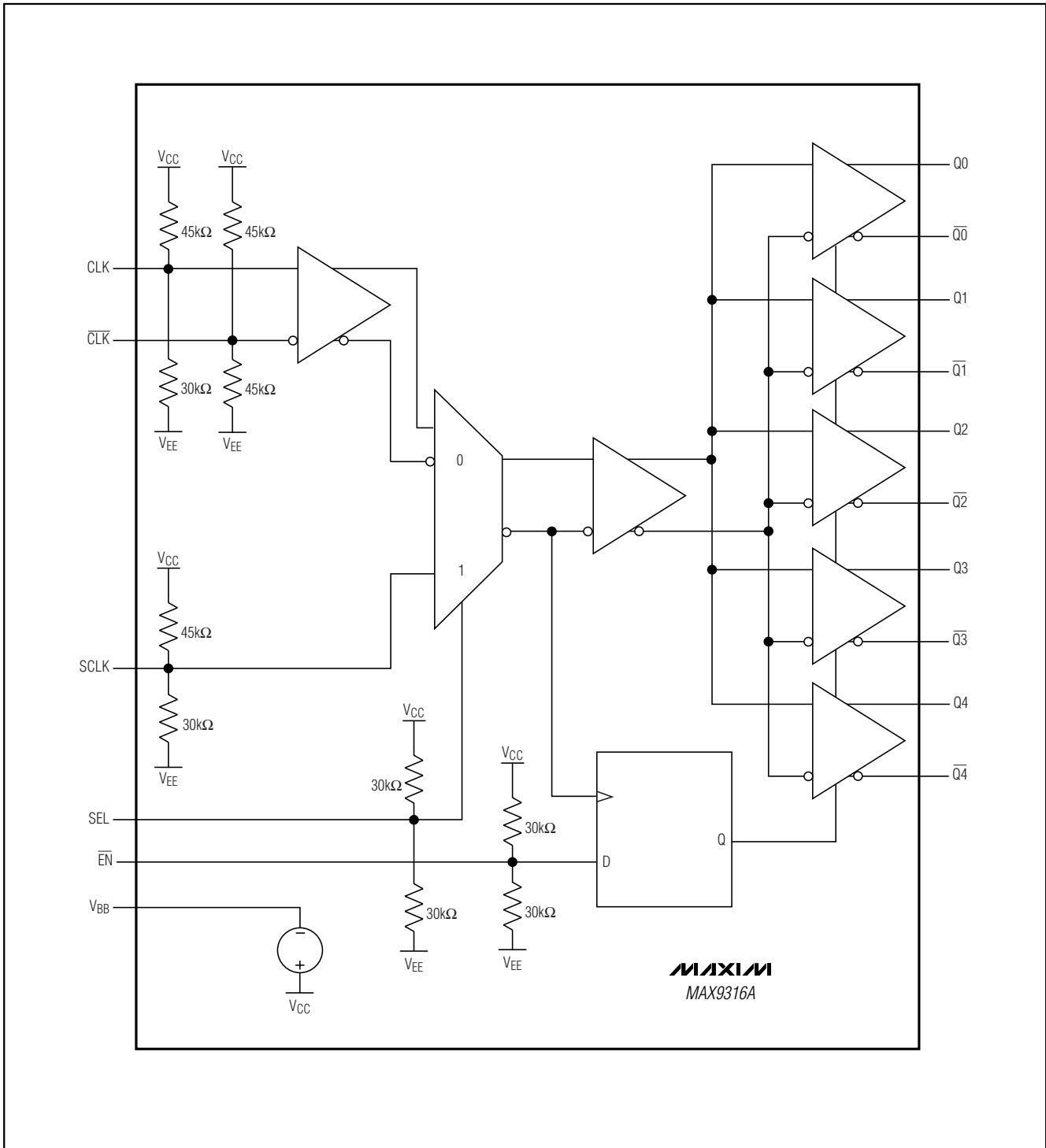
## Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

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TOP VIEW

| DIM | INCHES | | MILLIMETERS | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | 0.093 | 0.104 | 2.35 | 2.65 |
| A1 | 0.004 | 0.012 | 0.10 | 0.30 |
| B | 0.014 | 0.019 | 0.35 | 0.49 |
| C | 0.009 | 0.013 | 0.23 | 0.32 |
| e | 0.050 | | 1.27 | |
| E | 0.291 | 0.299 | 7.40 | 7.60 |
| H | 0.394 | 0.419 | 10.00 | 10.65 |
| L | 0.016 | 0.050 | 0.40 | 1.27 |

VARIATIONS:

| DIM | INCHES | | MILLIMETERS | | N | MS013 |
|---|---|---|---|---|---|---|
| | MIN | MAX | MIN | MAX | | |
| D | 0.398 | 0.413 | 10.10 | 10.50 | 16 | AA |
| D | 0.447 | 0.463 | 11.35 | 11.75 | 18 | AB |
| D | 0.496 | 0.512 | 12.60 | 13.00 | 20 | AC |
| D | 0.598 | 0.614 | 15.20 | 15.60 | 24 | AD |
| D | 0.697 | 0.713 | 17.70 | 18.10 | 28 | AE |

D

A

e   B   A1

FRONT VIEW

C

L

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SIDE VIEW

NOTES:
1. D&E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm (.006").
3. LEADS TO BE COPLANAR WITHIN 0.10mm (.004").
4. CONTROLLING DIMENSION: MILLIMETERS.
5. MEETS JEDEC MS013.
6. N = NUMBER OF PINS.

**DALLAS** SEMICONDUCTOR **MAXIM**

PROPRIETARY INFORMATION

TITLE:
PACKAGE OUTLINE, .300" SOIC

| APPROVAL | DOCUMENT CONTROL NO. | REV. | 1 |
|---|---|---|---|
| | 21-0042 | B | 1 |